



Surface Mount Superfast Recovery Bridge Rectifier

Reverse Voltage – 50 to 600 V

Forward Current – 1 A

FEATURES

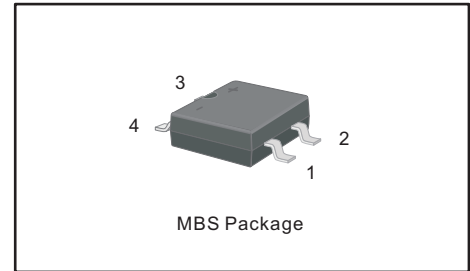
- For surface mounted applications
- Low profile package
- Glass Passivated Chip Junction
- Superfast reverse recovery time
- Lead free in comply with EU RoHS 2011/65/EU directives

MECHANICAL DATA

- Case: MBS
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 100mg / 0.0035oz

PINNING

PIN	DESCRIPTION
1	Input Pin (~)
2	Input Pin (~)
3	Output Anode (+)
4	Output Cathode (-)



Absolute Maximum Ratings and Characteristics

Ratings at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Parameter	Symbols	EMB1AS	EMB1BS	EMB1CS	EMB1DS	EMB1ES	EMB1GS	EMB1JS	Units
Maximum Repetitive Peak Reverse Voltage	V _{RRM}	50	100	150	200	300	400	600	V
Maximum RMS voltage	V _{RMS}	35	70	105	140	210	280	420	V
Maximum DC Blocking Voltage	V _{DC}	50	100	150	200	300	400	600	V
Maximum Average Forward Rectified Current	I _{F(AV)}	1							A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load	I _{FSM}	30							A
Maximum Forward Voltage at 1 A	V _F	1				1.25		1.68	V
Maximum DC Reverse Current at Rated DC Blocking Voltage	I _R	5							μA
T _a = 25 °C T _a =125 °C		100							
Typical Junction Capacitance (Note: 1)	C _j	15							pF
Maximum Reverse Recovery Time (Note: 2)	t _{rr}	35							ns
Typical Thermal Resistance (Note: 3)	R _{θJA}	80							°C/W
Operating and Storage Temperature Range	T _j , T _{stg}	-55 ~ +150							°C

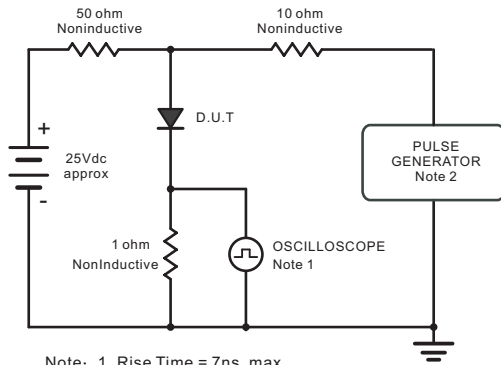
Note: 1. Measured at 1MHz and applied reverse voltage of 4 V D.C.

2. Measured with $I_F = 0.5\text{ A}$, $I_R = 1\text{ A}$, $t_{rr} = 0.25\text{ A}$.

3. Mounted on glass epoxy PC board with 4×1.5"×1.5" (3.81×3.81 cm) copper pad.



Fig.1 Reverse Recovery Time Characteristic And Test Circuit Diagram



Note: 1. Rise Time = 7ns, max.
Input Impedance = 1megohm, 22pF.
2. Rise Time = 10ns, max.
Source Impedance = 50 ohms.

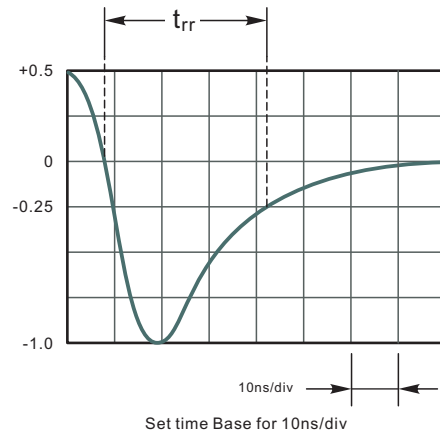


Fig.2 Maximum Average Forward Current Rating

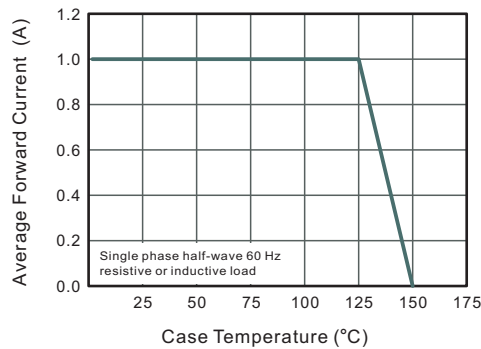


Fig.3 Typical Reverse Characteristics

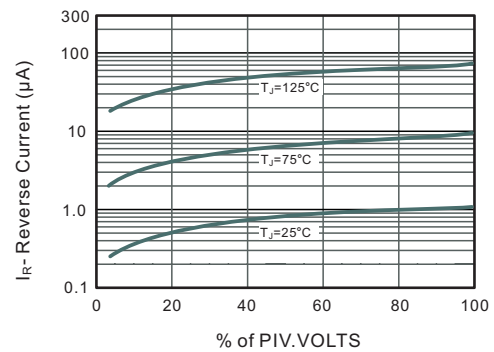


Fig.4 Typical Forward Characteristics

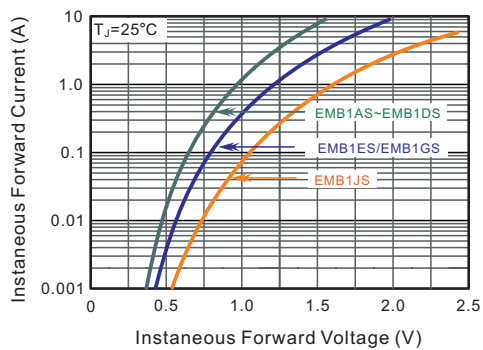


Fig.5 Typical Junction Capacitance

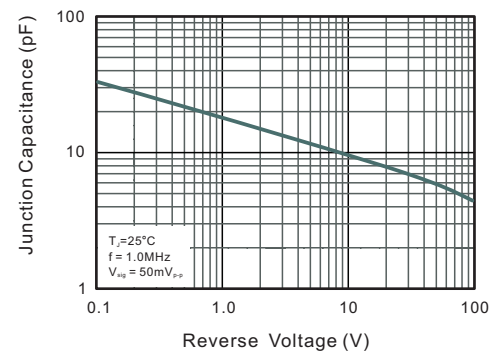
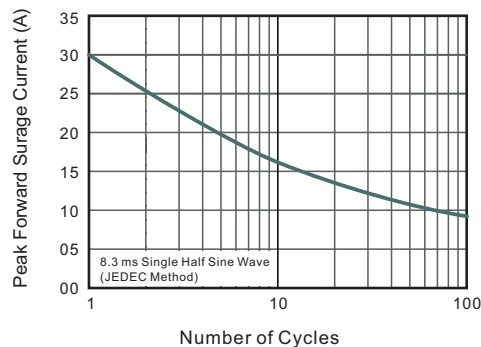


Fig.6 Maximum Non-Repetitive Peak Forward Surge Current

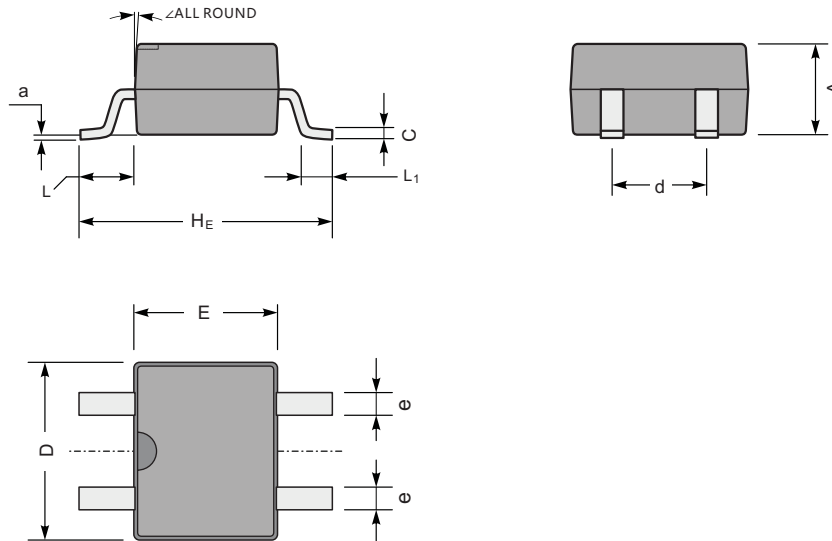




PACKAGE OUTLINE

Plastic surface mounted package; 4 leads

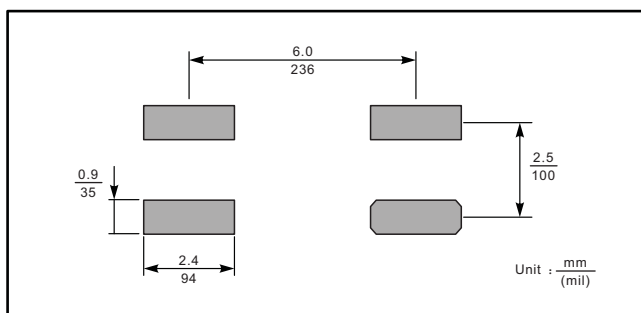
MBS



MBS mechanical data

UNIT		A	C	D	E	H_E	d	e	L	L_1	a	$\angle$
mm	max	2.6	0.22	5.0	4.1	7.0	2.7	0.7	1.7	1.1	0.2	7°
	min	2.2	0.15	4.5	3.6	6.4	2.3	0.5	1.3	0.5	—	
mil	max	102	8.7	197	161	276	106	28	67	43	8	
	min	94	5.9	177	142	252	91	20	51	20	—	

The recommended mounting pad size



Marking

Type number	Marking code
EMB1AS	EMB1AS
EMB1BS	EMB1BS
EMB1CS	EMB1CS
EMB1DS	EMB1DS
EMB1ES	EMB1ES
EMB1GS	EMB1GS
EMB1JS	EMB1JS